How to Create Delay-based Audio Effects on the TMS320C672x DSP

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ABSTRACT

TMS320C672x is a floating point device family from Texas Instruments that provides high quality audio performance at low prices. The price/performance ratio makes C672x well suited for numerous audio applications. This application note shows how to use C672x to efficiently create delay-based audio effects. The application note explains:

- How to leverage the data movement accelerator (dMAX) to move data for delay based applications.
- How to implement efficient block processing techniques in delay-based audio effects processing.

Along with this application note, an example application is provided that consists of the following four effects: equalizer, chorus, delay, and reverb.

This application report contains source code that can be downloaded from this link: http://www-s.ti.com/sc/pshysts/spraaa5/spraaa5.zip

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Trademarks
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1 Introduction to C672x

1.1 C672x Overview

C672x is a low cost high performance floating point device from Texas Instruments Inc for high quality audio application. Figure 1 shows the C672x block diagram. The key features of C672x are:

- **C672x**: 32-/64-bit 300-MHz floating-point DSPs
- upgrades to C67x+ CPU from C67x™ Family
  - 2X CPU registers [64 general-purpose]
  - new audio-specific instructions
  - compatible with the C67x CPU
- enhanced memory system
  - 256K-byte unified program/data RAM
  - 384K-byte unified program/data ROM
  - single-cycle data access from CPU
  - large program cache (32K byte) supports RAM, ROM, and external memory
- external memory interface (EMIF) supports:
  - 100-MHz SDRAM (16- or 32-bit)
  - asynchronous flash/SRAM (8-, 16-, or 32-bit)
- enhanced I/O system
  - high-performance crossbar switch
  - dedicated McASP DMA bus
  - deterministic I/O performance
- dual data movement accelerator (dMAX) supports:
  - 16 independent channels
  - concurrent processing of two transfer requests
  - 1-, 2-, and 3-dimensional memory-to-memory and memory-to-peripheral data transfers
  - circular addressing where the size of a circular buffer (FIFO) is not limited to $2^n$
  - table-based multi-tap delay read and write transfer from/to a circular buffer
- three multichannel audio serial ports
  - six clock zones and 16 serial data pins
  - supports TDM, I2S, and similar formats
  - DIT-capable (McASP2)
- universal host-port interface
  - 32-bit-wide data bus for high bandwidth
  - muxed and non-muxed address and data options
- two SPI ports with 3-,4- and 50pin options
- two inter-integrated circuit (I2C) ports
- real-time interrupt counter/watchdog
- oscillator- and software-controlled PLL

Applications
  - professional audio
    - mixers
    - effects boxes
    - audio synthesis
    - instrument/amp modeling
    - audio conferencing
    - audio broadcast
    - audio encoder
– emerging audio applications
– biometrics
– medical
– industrial
• commercial or extended temperature
• 144-pin, 0.5-mm, PowerPAD™ thin quad flatpack (TQFP) [RFP suffix]
• 256-terminal, 1.0-mm, 16x16 array plastic ball grid array (PBGA) [GDH and ZDH suffixes]

This document explains how to efficiently create delay-based effects using dMAX. For other details of C672x, please refer to TMS320C6727, TMS320C6726, TMS320C6722 Floating-Point Digital Signal Processors (SPRS268).

Figure 1. C672x Block Diagram

1.2 Introduction to dMAX

The dMAX is a module which can be programmed to handle data movement to/from any addressable memory space, including internal memory, peripherals, and external memory. The dMAX controller in the C672x has a different architecture from the previous EDMA controller in the C621x/C671x devices. Figure 2 shows a high level block diagram of dMAX.
There are two data movement engine in the dMAX module: HiMAX and LoMAX. Both modules are associated with an event group and dedicated to serve requests coming from the group. If requests occur at the same time, the event encoder sorts out all the events and picks out the two highest priority requests – one from each priority group, and serves them simultaneously. If the two requests compete for the same source and/or destination module, (i.e. they both access the internal memory), request from HiMAX completes first, followed by the transfer from LoMAX.
The dMAX controller supports two transfer modes:

- general purpose transfers which can be used to move audio samples multiplexed in one serial port to/from memory.
- FIFO transfers which manage a section of memory as a circular buffer for delay-tap based reading and writing of data.

Figure 3 illustrates how dMAX transfers a block of 2N samples from 2 channels multiplexed on one McASP port to the memory. The receiving buffer for each channel is size N and the two buffers are consecutive in memory.

![Diagram](image)

Figure 3. General Purpose (3-dimensional) Transfer from McASP to Memory

Figure 4 shows how a FIFO read transfer pulls data from a circular buffer to the processing buffer to implement the following two echo equations.

\[
Y_{L,k} = \frac{(L_k + L_{k-D1})}{2}, k = n, n-1, \ldots, n-(N-1)
\]

\[
Y_{R,k} = \frac{(R_k + R_{k-D2})}{2}, k = n, n-1, \ldots, n-(N-1)
\]

There are two channels, each of which has a section with size \( T \) in the circular buffer. \( N \) output samples ( \( k=n, n-1, \ldots, n-(N-1) \) ) are computed for each channel. \( Y_{L,k} \) (\( Y_{R,k} \)) is the \( k^{th} \) output of the left (right) channel. \( L_k \) (\( R_k \)) denotes the \( k^{th} \) input of the left (right) channel. \( L_{k,D1} \) (\( R_{k,D2} \)) is the \( k^{th} \) delay sample of the left (right) channel, where \( D1 \) (\( D2 \)) is the delay tap value for the left (right) channel.

For \( Y_{L,k} \), the \( D1^{th} \) previous sample \( L_{k,D1} \) is summed with the current input sample \( L_k \) and the result is divided by 2 to produce the echo effect.

For \( Y_{R,k} \), the \( D2^{th} \) previous sample \( R_{k,D2} \) is summed with the current input sample \( R_k \) and the result is divided by 2 to produce the echo effect.

For the left channel, both the current block of inputs (\( L_n, L_{n-1}, \ldots, L_{n-(N-1)} \)) and delay samples (\( L_{n-D1}, L_{n-D1-1}, \ldots, L_{n-D1-(N-1)} \)) are transferred from the circular buffer into the processing buffer. Similarly for the right channel, both the current block of inputs (\( R_n, R_{n-1}, \ldots, R_{n-(N-1)} \)) and delay samples (\( R_{n-D2}, R_{n-D2-1}, \ldots, R_{n-D2-(N-1)} \)) are transferred from the circular buffer into the processing buffer.
For further details on dMAX data transfers, please refer to TMS320C672x DSP Dual Data Movement Accelerator (dMAX) Reference Guide (SPRU795).

2 Application Algorithm Description

The example application consists of four effects which are cascaded in serial as shown in Figure 5. It covers some of the typical delay-based effects in the professional audio space. Free source code is provided which can be used as is or modified to create a new application. Samples from the two input channels (left and right) are time-multiplexed on the same McASP and processed through the identical algorithms. However, the two channels are separated for processing so that the parameters for each one of the channels can be changed without affecting the other.

Figure 5. Application Block Diagram
2.1 **Equalizer**

Equalizers are used to adjust the amplitude of a signal within selected frequency ranges. Figure 6 shows a bi-quad IIR filter used to implement the equalizer in our example. Depending on the filter parameters configured by the user, the filter can be high pass, low pass or band pass.

![Equalizer Block Diagram](image)

Figure 6. Equalizer Block Diagram

Computing each \( \text{out}[n] \) requires 5 multiplications and 4 additions. Two middle stage results \( \text{w}[n] \) and \( \text{w}[n-1] \) need to be saved.

Figure 7 shows the block-processing diagram. Assuming a block of \( N \) samples are processed at a time for each channel, the size of \( \text{EqInBuf} \) and \( \text{EqOutBuf} \) are \( N \) samples each. The size of \( \text{EqWBuf} \) is 2 samples. Thus, the total data buffer size for this equalizer is \( 2 \times N + 2 \).

![Block-Processing Diagram for Equalizer Module](image)

Figure 7. Block-Processing Diagram for Equalizer Module

2.2 **Chorus Effect**

Chorus is a time delay algorithm used to "thicken" sounds. It duplicates the effect that occurs when many musicians play the same instrument and same music part simultaneously. Musicians are usually synchronized with one another, but there are always slight differences in timing, volume and pitch between each instrument. Such chorus effect can be re-created digitally by adding time-varying delayed result together with the input signal.

Figure 8 shows the chorus algorithm implemented in the example.

![Chorus Effect Algorithm Block Diagram](image)

Figure 8. Chorus Effect Algorithm Block Diagram

The LFO module is a software implemented low-frequency oscillator for generating time-varying delayed samples. A typical and efficient implementation is to use a periodical waveform to modulate the delay. When the waveform reaches a maximum, then the delay is at its largest value. Four LFO waves are provided in the program: sine wave, square wave, triangle wave and sawtooth wave. User can select any one of them to produce desired effect.
One thing to note is that Figure 8 is a diagram showing single-sample processing, which implies one time-varying delay value is computed for each input sample using LFO. To update the stored sample it takes 1 multiplication and 1 addition each round. To compute each output sample, it takes 2 multiplications and 1 addition. Thus, the total computation for each sample consists of 3 multiplications, 2 additions and 1 LFO modulation.

Figure 9 shows the block-processing diagram for chorus. To process a block of N samples at a time, one time-varying delay value has to be generated for each block. The generated delay is used by the dMAX to pull in the block of required samples from the circular buffer using a FIFO read transfer. Three blocks of processing buffers are necessary for this example:

- **ChoInBuf** is the output from the equalizer (EqOutBuf) and the input to the chorus module.
- **ChoOutBuf** is the output of the chorus module.
- **ChoDlyBuf** saves the delayed samples received from the circular buffer using FIFO read before processing starts. It is updated during the processing. After processing, it will be transferred to the circular buffer by FIFO write.

![Figure 9. Block-Processing Diagram for Chorus Module](image)

### 2.3 Delay Effect

Figure 10 shows the delay effect implemented in the example. Compared to chorus, the delay D is fixed in this case and typically represents tens of milliseconds of delay. Compared to the equalizer shown in Section 2.1, a block of N samples can be processed at a time as long as D > N-1. This is because if D > N-1, for every block of N input samples in[n] ... in[n-(N-1)], w[n-D] ... w[n-D-(N-1)] are already in the circular buffer, and thus they can be transferred to the processing buffer and processed with the input samples together.

![Figure 10. Delay Effect Algorithm Block Diagram](image)

Computing each w(n) and out[n] requires 2 multiplications and 2 additions. One middle stage result w[n] needs to be saved.

Figure 11 shows the block-processing diagram. Three blocks of processing buffers are necessary to process a block of N samples:

- **DlyInBuf** is the output from the chorus (ChoOutBuf) and input to the delay module.
- **DlyOutBuf** is the output of the delay module.
- **DlyWBuf** saves the delay samples received from the circular buffer using a FIFO read transfer before processing starts. The updated samples will be transferred to the circular buffer by a FIFO write transfer.
2.4 Reverberation Effect

The reverberation algorithm simulates the effect of sound reflections in a large concert hall or room. Instead of using only a few discrete repetitions of a sound like a multi-tap delay effect, the reverb effect implements many delayed repetitions so close together in time that the ear cannot distinguish the differences between the delays. The repetitions are blended together to sound continuous.

Figure 12 shows a simple reverb algorithm implemented in our example. It consists of a 6-tap echo filter and four all-pass filters (APFs).

For each input sample, the 6-tap echo filter takes 6 multiplications and 6 additions to compute an output. To update bufA[n] and lp[k] for each APF, it takes 4 multiplications and 2 additions. To compute an output for each APF, it takes 2 multiplications and 1 addition. The reverb output is the summation of all the APFs which requires 4 additions. Thus, the total computation for each sample takes 30 multiplications and 28 additions.
Implementation Considerations

Figure 13 shows the block-processing diagram. 12 blocks of processing buffers are necessary to process a block of N samples at a time.

- \textit{EchoInBuf} is the output from the delay module and input to the echo filter in the reverb module.
- \textit{RevOutBuf} is the output of the reverb module.
- \textit{EchoDlyDkBuf} \((k=0...5)\) saves the delay samples received from the circular buffer for the echo filter.
- \textit{APFkBuf} \((k=0...3)\) saves the delay samples for the APF \(k\) before processing starts from the circular buffer. After processing, the updated samples are transmitted to the circular buffer by FIFO write.

\begin{itemize}
  \item Note: Because each APF output is computed sample by sample, no processing buffer is needed. For each APF, only one sample for \(lp\) needs to be buffered.
\end{itemize}

\begin{figure}
\centering
\includegraphics[width=\textwidth]{block-processing-diagram.png}
\caption{Block-Processing Diagram for Reverb Module}
\end{figure}

3 Implementation Considerations

The performance of an embedded system depends not only on how the hardware is designed, but also on how the software utilizes the hardware. Generally speaking, the architecture of C672x suggests the following choices to implement a delay-based audio effect algorithm such as the one described in Section 2.

- Block processing instead of single-sample processing. There are several folds of benefits from block processing which will be described in Section 5. However, one thing to note is that the block size is constrained both by the on-chip memory size and the latency requirement. The latency requirement often imposes the more stringent limitation. For example, some professional audio systems require the latency to be smaller than 10ms, which is about 480 sample periods for a 48-KHz sample rate. Since a latency of 20 to 100 sample periods are always caused due to the hardware limitations, i.e., the D/A converter latency, for this case it is safe to set the block size up to 256 samples. Too fulfill a stricter latency requirement, the block size has to be smaller.
Implementation Considerations

- Saving delay samples in off-chip memory and processing samples in on-chip memory. The off-chip SDRAM has relatively larger size but significantly lower speed compared to on-chip SRAM. It can be used to store the delay samples for the algorithm. To process a block of data, it is recommended to transfer the delay samples to SRAM which runs at the same frequency as the DSP core. If the algorithm program size is less 32KB, it can completely fit into the L1P cache.

- Moving data using dMAX.
  - The FIFO transfer mode in dMAX is well designed for efficiently transferring data between a circular buffer in the SDRAM and a processing buffer in the SRAM. One obvious benefit is that DSP can be used to do the processing work while dMAX is transferring the data. Compared to the EDMA architecture in some other C6000 DSPs, the FIFO transfer feature of dMAX has another advantage for audio systems. Imagine using EDMA to perform the transfer shown in Figure 4, which would require the use of four linked 1-D transfers*. However, since the circular buffer’s read/write pointers are not updated by EDMA automatically, the DSP must manually update them. Also, every time a transfer is completed the DSP needs to update the source/destination address for each block. Things get even worse if one block rolls over from the bottom to the top of the circular buffer, because the transfer has to be manually split into two transfers.

  Note: It is not always possible to use a 2-D EDMA transfer in this case because it is often T!=D1 !D=D2.

  - For any FIFO transfer, rolling over the read/write pointer in the middle of a block transfer should be avoided as much as possible. Although dMAX can automatically handle this situation by splitting one transfer into two, this increases the transfer overhead. To avoid this situation, it is recommended to make the circular buffer size a multiple of the processing block size. Also, the read/write pointer should be aligned to the processing block size. This ensures that the read/write pointer will only be rolled over in-between block transfers.
  - The dMAX general purpose transfer is designed to efficiently transfer input/output audio samples to/from memory. The general purpose transfer can automatically de-multiplex/multiplex samples of different channels from/to the same serial port.

- Pipelined processing. The dMAX in the C672x is naturally designed to support a PING-PONG buffer scheme for pipelined processing. While the DSP is processing the PING (PONG) buffer, data can be transferred to/from the PONG (PING) buffer for the next round of processing.
3.1 Buffer Organization

Section 2 explained the necessary processing buffers for each effect module to be implemented. Table 1 summarizes these processing buffers. Please refer to Figure 5 for all the effect modules.

<table>
<thead>
<tr>
<th>Buffer Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>InBuf, EqInbuf</td>
<td>This is the buffer used to receive the input samples from the McASP and also serves as the input buffer to the equalizer module.</td>
</tr>
<tr>
<td>EqOutBuf, CholInBuf</td>
<td>This is the output buffer for the equalizer module and also the input buffer for the chorus module.</td>
</tr>
<tr>
<td>ChoDlyBuf</td>
<td>This buffer saves the delay samples received from the circular buffer for the chorus module using FIFO read before processing starts. After processing, the updated ones will be transferred to the circular buffer by FIFO write.</td>
</tr>
<tr>
<td>ChoOutBuf, DlyInBuf</td>
<td>This is the output buffer for the chorus module and also the input buffer for the delay module.</td>
</tr>
<tr>
<td>DlyWBuf</td>
<td>This buffer saves the delay samples received from the circular buffer for the delay module using FIFO read before processing starts. After processing, The updated samples will be transferred to the circular buffer by FIFO write.</td>
</tr>
<tr>
<td>DlyOutBuf, EchoInBuf</td>
<td>This is the output buffer for the delay module and also the input buffer for the echo filter in the reverb module.</td>
</tr>
<tr>
<td>EchoDlyDkBuf, K=0…5</td>
<td>These 6 buffers save the delay samples received from the circular buffer for the echo filter in the reverb module before processing starts.</td>
</tr>
<tr>
<td>APFkBuf, k=0…3</td>
<td>These 4 buffers save the delay samples received from the circular buffer for the 4 APFs in the reverb module before processing starts. After processing, The updated samples will be transferred to the circular buffer by FIFO write.</td>
</tr>
<tr>
<td>OutBuf, RevOutBuf</td>
<td>This is the output buffer of the reverb module. It also serves as the output buffer for the system to transmit output samples to the McASP.</td>
</tr>
</tbody>
</table>

Since we separate the left and right channels and use PING-PONG buffer scheme, 4x the number of processing buffers are needed. To identify a particular buffer for a particular channel in the particular PING/PONG set, we use the following naming convention in the rest of the document.

\[\text{[SET = PING or PONG]"buffer name" [CHAN = L or R]}\]

For example, to refer to the input buffer to the equalizer module of the left channel in the PING set, we use \text{PING\_L\_EqInbuf}.

Figure 14 shows all the processing buffers which reside in on-chip SRAM.

For the buffers in pattern 1, data is transferred between the buffers and the circular buffer bi-directionally using dMAX FIFO read and FIFO Write Transfers.

For the buffers in pattern 2, data is transferred to the buffers from the circular buffer by dMAX FIFO read transfer.

For the buffers in pattern 3, data is transferred between the buffers and the McASP by dMAX general purpose transfers.

For the buffers in pattern 4, no dMAX transfers are involved.
There are seven sections for each channel in the circular buffer. Due to processing separation for the left and right channel, the number of sections in the circular buffer is 14 in total. For each channel, the data sections to be saved in the circular buffer include:

1. Delay line for the chorus module. Before a round of processing starts, delay samples are transferred to ChoDlyBuf by FIFO read. After processing, updated samples are transferred from ChoDlyBuf to it by FIFO write. We use L.ChoDlySect and R.ChoDlySect to denote this section for the left and right channel, respectively.

2. Delay line for the delay module. Before a round of processing starts, delay samples are transferred to DlyWBuf by FIFO read. After processing, updated samples are transferred from DlyWBuf to it by FIFO write. We use L.DlyWSect and R.DlyWSect to denote this section for the left and right channel, respectively.

3. Delay line for the echo filter in the reverb module. Before a round of processing starts, delay samples are transferred to EchoDlyDkBuf (k=0…5) by FIFO read. After processing, latest samples in EchoInBuf are transferred to it by FIFO write. We use L.EchoDlySect and R.EchoDlySect to denote this section for the left and right channel, respectively.

4. Delay line for each APFk (k=0…3) in the reverb module. Before a round of processing starts, delay samples are transferred to APFkBuf by FIFO read. After processing, updated samples are transferred from APFkBuf to it by FIFO write. We use L.APFkSect and R.APFkSect to denote this section for the left and right channel, respectively.

Since a delay line often needs to keep tens of thousands of samples, the circular buffer is put in SDRAM. The following figure shows the circular buffer organization.
Implementation Considerations

Figure 15. Circular Buffer Organization

In each processing round for a FIFO write transfer, seven blocks for the left channel and seven blocks for the right channel need to be transferred to the circular buffer. Table 2 shows the entry values in the FIFO write transfer’s delay table in which size("section name") denotes the size of a particular section.
Table 2. FIFO Write Delay Table Values

<table>
<thead>
<tr>
<th>Entry ID</th>
<th>Entry Value</th>
<th>Comment</th>
</tr>
</thead>
<tbody>
<tr>
<td>FIFOW_Entry[0]</td>
<td>0</td>
<td>Transfer from L_EchoInBuf</td>
</tr>
<tr>
<td>FIFOW_Entry[1]</td>
<td>size(L_EchoDlySect)</td>
<td>Transfer from L_APF0Buf</td>
</tr>
<tr>
<td>FIFOW_Entry[2]</td>
<td>FIFOW_Entry[1] + size(L_APF0Sect)</td>
<td>Transfer from L_APF1Buf</td>
</tr>
<tr>
<td>FIFOW_Entry[9]</td>
<td>FIFOW_Entry[8] + size(R_DlyW Sect)</td>
<td>Transfer from R_APF0Buf</td>
</tr>
<tr>
<td>FIFOW_Entry[10]</td>
<td>FIFOW_Entry[9] + size(R_APF0Sect)</td>
<td>Transfer from R_APF1Buf</td>
</tr>
<tr>
<td>FIFOW_Entry[13]</td>
<td>FIFOW_Entry[12] + size(R_APF3Sect)</td>
<td>Transfer from R_EchoInBuf</td>
</tr>
</tbody>
</table>

Figure 16 shows how a FIFO write transfer fills the circular buffer from the PING set processing buffers. Again, since a FIFO write transfer requires index0 and index1 to be fixed, we place all the processing buffers associated with FIFO write contiguously so that index1 = 1.
Implementation Considerations

In a processing round for a FIFO read transfer, 13 blocks for data for each channel need to be transferred from the circular buffer to the processing buffers. Table 3 shows the entry values in the FIFO read transfer's delay table.

<table>
<thead>
<tr>
<th>Entry ID</th>
<th>Entry Value</th>
<th>Comment</th>
</tr>
</thead>
<tbody>
<tr>
<td>FIFOR_Entry[0]</td>
<td>L_D0</td>
<td>Transfer from L_EchoDlySect to L_EchoDlyD0Buf. L_D0 is the 1st delay tap for the echo filter of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[1]</td>
<td>L_D1</td>
<td>Transfer from L_EchoDlySect to L_EchoDlyD1Buf. L_D1 is the 2nd delay tap for the echo filter of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[2]</td>
<td>L_D2</td>
<td>Transfer from L_EchoDlySect to L_EchoDlyD2Buf. L_D2 is the 3rd delay tap for the echo filter of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[3]</td>
<td>L_D3</td>
<td>Transfer from L_EchoDlySect to L_EchoDlyD3Buf. L_D3 is the 4th delay tap for the echo filter of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[4]</td>
<td>L_D4</td>
<td>Transfer from L_EchoDlySect to L_EchoDlyD4Buf. L_D4 is the 5th delay tap for the echo filter of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[5]</td>
<td>L_D5</td>
<td>Transfer from L_EchoDlySect to L_EchoDlyD5Buf. L_D5 is the 6th delay tap for the echo filter of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[6]</td>
<td>L_D5</td>
<td>Transfer from L_EchoDlySect to L_DlyOutbuf. It is an unnecessary transfer.</td>
</tr>
<tr>
<td>FIFOR_Entry[7]</td>
<td>FIFOW_Entry[1] + L_APF0Dly</td>
<td>Transfer from L_APF0Sect to L_APF0Buf. L_APF0Dly is the delay tap for the APF 0 of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[8]</td>
<td>FIFOW_Entry[2] + L_APF1Dly</td>
<td>Transfer from L_APF1Sect to L_APF1Buf. L_APF1Dly is the delay tap for the APF 1 of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[9]</td>
<td>FIFOW_Entry[3] + L_APF2Dly</td>
<td>Transfer from L_APF2Sect to L_APF2Buf. L_APF2Dly is the delay tap for the APF 2 of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[10]</td>
<td>FIFOW_Entry[4] + L_APF3Dly</td>
<td>Transfer from L_APF3Sect to L_APF3Buf. L_APF3Dly is the delay tap for the APF 3 of the left channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[15]</td>
<td>FIFOW_Entry[9] + R_APF0Dly</td>
<td>Transfer from R_APF0Sect to R_APF0Buf. R_APF0Dly is the delay tap for the APF 0 of the right channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[16]</td>
<td>FIFOW_Entry[10] + R_APF1Dly</td>
<td>Transfer from R_APF1Sect to R_APF1Buf. R_APF1Dly is the delay tap for the APF 1 of the right channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[18]</td>
<td>FIFOW_Entry[12] + R_APF3Dly</td>
<td>Transfer from R_APF3Sect to R_APF3Buf. R_APF3Dly is the delay tap for the APF 3 of the right channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[20]</td>
<td>FIFOW_Entry[13] + R_D0</td>
<td>Transfer from R_EchoDlySect to R_EchoDlyD0Buf. R_D0 is the 1st delay tap for the echo filter of the right channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[21]</td>
<td>FIFOW_Entry[13] + R_D1</td>
<td>Transfer from R_EchoDlySect to R_EchoDlyD1Buf. R_D1 is the 2nd delay tap for the echo filter of the right channel.</td>
</tr>
<tr>
<td>FIFOR_Entry[22]</td>
<td>FIFOW_Entry[13] + R_D2</td>
<td>Transfer from R_EchoDlySect to R_EchoDlyD2Buf. R_D2 is the 3rd delay tap for the echo filter of the right channel.</td>
</tr>
</tbody>
</table>
Figure 17 shows how a FIFO read transfer fills the PING set processing buffers. A FIFO read transfer requires \texttt{index0} and \texttt{index1} to be fixed for all blocks, which is why we put all the processing buffers associated with FIFO read contiguously so that \texttt{index1} = 1.

\texttt{L_DlyOutBuf} and \texttt{R_DlyOutBuf} are actually for saving the output of delay modules and do not need to be filled by FIFO read (see the dash lines arrows in Figure 17). However, the data in them need to be transferred to circular buffer by the FIFO write transfer. By putting them in such places and copying two extra buffers, only one FIFO read transfer (and thus only one interrupt) is necessary to fill all the necessary processing buffers for two channels. Otherwise, two FIFO transfers (one for each channel) are needed. Since usually the processing buffer size is small (about 4 - 256 samples) for targeted application, the performance will gain by reducing an interrupt.

Copying extra buffers is not the only method to save an interrupt as described above. In the provided application, we encounter such a scenario because we want to separate the processing buffers for each channel to give user a clear view. The following are general guidance of how to place the processing buffers in order.

For each PING or PONG set,
1. For all the processing buffers involved with FIFO read only
   a. Place them contiguously.
   b. Place all the buffers accessing the same section in the circular buffer contiguously.
   c. Record the order of the circular buffer section.
2. For all the processing buffers involved with FIFO write only
   a. Place them contiguously. The order is the same as the one recorded in 1-c.
3. For all the processing buffers involved with both FIFO read and write
   a. Place them contiguously.
   b. Place all the buffers accessing the same section in the circular buffer contiguously.
4. Place 3 between 1 and 2.
5. The section order of the circular buffer follows the processing buffer orders.
6. For those processing buffers not involved with FIFO transfer, we do not care about their placement order.

For example, an optimized processing buffer placement order for this application is shown in Figure 18.

![Figure 18. Optimized Processing Buffer Organization](image)

All the buffers in pattern 2 are involved with FIFO read transfer only and are placed contiguously (rule 1-a).

PING\_L\_EchoDlyDkBuf \((k=0\ldots5)\) receive samples from L\_EchoDlySect and they are placed contiguously (rule 1-b). PING\_R\_EchoDlyDkBuf receive samples from R\_EchoDlySect and are placed contiguously too (rule 1-b).

The order of the involved circular buffer sections is L\_EchoDlySect -> R\_EchoDlySect (rule 1-c).

PING\_R\_DlyOutBuf and PING\_L\_DlyOutBuf (in pattern 3) are involved with FIFO write only and are placed contiguously. Their order is the same as L\_EchoDlySect -> R\_EchoDlySect (rule 2-a).

All the buffers in pattern 1 are involved with both FIFO read and write. They are put contiguously (rule 3-a). Since each one corresponds to a section in the circular buffer, rule 3-b is automatically met.

All the buffers in pattern 1 are placed between the ones in pattern 2 and the ones in pattern 3 (rule 4).

The section order in the circular buffer is shown in Figure 18. It is the same order as the processing buffers (rule-5).

Table 4 and Table 5 show the one-to-one correspondence between the circular buffer sections and processing buffers for the FIFO read and FIFO write transfer.
### Implementation Considerations

#### Table 4. Optimized FIFO Read Between the Circular Buffer and Processing Buffers

<table>
<thead>
<tr>
<th>Processing Buffers</th>
<th>Data Direction</th>
<th>Sections in the Circular Buffer</th>
</tr>
</thead>
<tbody>
<tr>
<td>PING_L_EchoDlyDkBuf (k=0...5)</td>
<td>←</td>
<td>Sect 0: L_EchoDlySect</td>
</tr>
<tr>
<td>PING_R_EchoDlyDkBuf (k=0...5)</td>
<td>←</td>
<td>Sect 1: R_EchoDlySect</td>
</tr>
<tr>
<td>PING_L_APF0Buf</td>
<td>←</td>
<td>Sect 2: L_APF0Sect</td>
</tr>
<tr>
<td>PING_L_APF1Buf</td>
<td>←</td>
<td>Sect 3: L_APF1Sect</td>
</tr>
<tr>
<td>PING_L_APF2Buf</td>
<td>←</td>
<td>Sect 4: L_APF2Sect</td>
</tr>
<tr>
<td>PING_L_APF3Buf</td>
<td>←</td>
<td>Sect 5: L_APF3Sect</td>
</tr>
<tr>
<td>PING_R_APF0Buf</td>
<td>←</td>
<td>Sect 6: R_APF0Sect</td>
</tr>
<tr>
<td>PING_R_APF1Buf</td>
<td>←</td>
<td>Sect 7: R_APF1Sect</td>
</tr>
<tr>
<td>PING_R_APF2Buf</td>
<td>←</td>
<td>Sect 8: R_APF2Sect</td>
</tr>
<tr>
<td>PING_R_APF3Buf</td>
<td>←</td>
<td>Sect 9: R_APF3Sect</td>
</tr>
<tr>
<td>PING_L_ChoDlyBuf</td>
<td>←</td>
<td>Sect 10: L_ChoDlySect</td>
</tr>
<tr>
<td>PING_R_ChoDlyBuf</td>
<td>←</td>
<td>Sect 11: R_ChoDlySect</td>
</tr>
<tr>
<td>PING_L_DlyWBuf</td>
<td>←</td>
<td>Sect 12: L_DlyWSect</td>
</tr>
<tr>
<td>PING_R_DlyWBuf</td>
<td>←</td>
<td>Sect 13: L_DlySect</td>
</tr>
</tbody>
</table>

#### Table 5. Optimized FIFO Write Between the Circular Buffer and Processing Buffers

<table>
<thead>
<tr>
<th>Processing Buffers</th>
<th>Data Direction</th>
<th>Sections in the Circular Buffer</th>
</tr>
</thead>
<tbody>
<tr>
<td>PING_L_APF0Buf</td>
<td>→</td>
<td>Sect 2: L_APF0Sect</td>
</tr>
<tr>
<td>PING_L_APF1Buf</td>
<td>→</td>
<td>Sect 3: L_APF1Sect</td>
</tr>
<tr>
<td>PING_L_APF2Buf</td>
<td>→</td>
<td>Sect 4: L_APF2Sect</td>
</tr>
<tr>
<td>PING_L_APF3Buf</td>
<td>→</td>
<td>Sect 5: L_APF3Sect</td>
</tr>
<tr>
<td>PING_R_APF0Buf</td>
<td>→</td>
<td>Sect 6: R_APF0Sect</td>
</tr>
<tr>
<td>PING_R_APF1Buf</td>
<td>→</td>
<td>Sect 7: R_APF1Sect</td>
</tr>
<tr>
<td>PING_R_APF2Buf</td>
<td>→</td>
<td>Sect 8: R_APF2Sect</td>
</tr>
<tr>
<td>PING_R_APF3Buf</td>
<td>→</td>
<td>Sect 9: R_APF3Sect</td>
</tr>
<tr>
<td>PING_L_ChoDlyBuf</td>
<td>→</td>
<td>Sect 10: L_ChoDlySect</td>
</tr>
<tr>
<td>PING_R_ChoDlyBuf</td>
<td>→</td>
<td>Sect 11: R_ChoDlySect</td>
</tr>
<tr>
<td>PING_L_DlyWBuf</td>
<td>→</td>
<td>Sect 12: L_DlyWSect</td>
</tr>
<tr>
<td>PING_L_DlyOutBuf</td>
<td>→</td>
<td>Sect 0: L_EchoDlySect</td>
</tr>
<tr>
<td>PING_R_DlyOutBuf</td>
<td>→</td>
<td>Sect 1: R_EchoDlySect</td>
</tr>
</tbody>
</table>
3.2 **PING-PONG Scheme**

Figure 19 illustrates how the PING-PONG buffer scheme works.

![PING-PONG Buffer Scheme Flow](image)

1. CPU starts processing the data in the PING (PONG) set processing buffers after the following four transfers are completed. Transfer a is the last one to finish.
   a. A block of input samples are transferred from McASP_in to PING (PONG) input buffers by dMAX. The input samples will be processed by the CPU.
   b. All the PING (PONG) set processing buffers associated with FIFO read have been filled by dMAX. These buffers will be used with input samples for processing by the CPU.
   c. The circular buffer has been updated in the last round. It is updated by a FIFO write which transfers data from associated PONG (PING) set processing buffers to the circular buffer.
   d. The output samples (which are generated during the one before the last round) in the PING (PONG) set output buffers have been transferred to McASP_out.

2. When CPU starts processing the data in the PING (PONG) set processing buffer, another FIFO read is triggered by CPU to prepare for the processing buffers for the next round. dMAX will perform the transfer to fill the PONG (PING) set processing buffers associated with FIFO read.

3. After CPU finishes processing the PING (PONG) set data, the output data are put in the PING (PONG) set output buffer which will be transferred to McASP_out by dMAX when the previous transfer is completed. Meanwhile, another FIFO write is triggered by CPU to update the circular buffer. The new data in the PING (PONG) set processing buffers associated with FIFO write are transferred to the circular buffer by dMAX.

The PING-PONG scheme described above assumes that the following conditions are met.

\[ t(\text{get input block}) > t(\text{FIFO read}) \]

where \( t(\text{get input block}) \) is the time interval to transfer a block of input samples from McASP_in to the input processing buffer, and \( t(\text{FIFO read}) \) is the time interval for a FIFO Read Transfer.

\[ t(\text{get input block}) > t(\text{processing}) + t(\text{FIFO write}) \]
where \( t(\text{processing}) \) is the time interval DSP takes to process 2 blocks (one for left and one for right channel) of input samples, and \( t(\text{FIFO_write}) \) is the time interval for a FIFO Write Transfer.

Given the audio sample rate as 96-KHz, we can show that these two conditions can easily be met on C672x.

Let us assume that it takes \( 30 \times d\text{MAX} \) cycles in average to move a sample between on-chip SRAM and SDRAM. Given the \( d\text{MAX} \) frequency is 150-MHz, for a block of size 32, the FIFO Read Transfer takes

\[
26 \times 32 \times 30 / 150 \text{MHz} = 0.1664 \text{ms},
\]

where 26 is the number of blocks to be transferred.

**Note:** An experiment shows that to transfer a block of 32 sequential samples (each of which is 32-bit) between the SDRAM and internal memory, it takes about 273 \( d\text{MAX} \) cycles if the QTSL is set to 16 and there is no resource competition. Here, we loosely assume it takes 30 \( d\text{MAX} \) cycles in average to transfer per sample to take into account the fact that FIFO read and FIFO write transfer may compete for accessing the SDRAM and internal memory.

To transfer two input blocks from McASP_in to the input processing buffers, it takes

\[
2 \times 32 / 96 \text{KHz} = 0.6667 \text{ms}
\]

Thus, the 1\text{st} condition can be easily met.

The FIFO Write Transfer will take

\[
14 \times 32 \times 30 / 150 \text{MHz} = 0.0896 \text{ms},
\]

where 14 is the number of blocks to be transferred to the circular buffer. Thus, the number of DSP cycles left for processing is (0.6667ms - 0.0896ms) x 300 MHz = 0.17313 x 10^6 cycles. For fully optimized code on C672x, computing the product of two 32-element floating vectors takes less than 50 cycles. Thus, the cycles left for processing are more than enough for the example application.

## 4 Pseudo Code Example

The following pseudo code example shows the overall application behavior.

### Example 1. Pseudo Code

```c
Variables:
Int currWkBufs; // the current buffer being processed, PING or PONG
Int currInBuf; // the current input buffer being processed, PING or PONG
Int currOutBuf; // the current output buffer being processed, PING or PONG
Int allBufRdyFlg; // flag indicating buffer transfer status:
                    // input, output, FIFO write, FIFO read

Function:
// application kernel function
void app() {

app_start:
  // wait for the following events:
  // a new frame of input samples are received;
  // the previous frame of output samples are transmitted
  // the circular buffer has been updated (triggered in the previous round)
  // the processing buffer has been filled (triggered in the previous round)
  while (!allBufRdyFlg);
  allBufRdyFlg = 0; // clean the flag
  if ( parameters_changed() )
    apply_change(); // if any parameter is changed by user, apply the change.

  // decide which set to be processed and updated
  SWITCH_PINGPONG( currWkBufs ); // the set to be computed
  SWITCH_PINGPONG( nextWkBufs ); // the set to be filled by FIFO read for the
                                // next round
}
```

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How to Create Delay-based Audio Effects on the TMS320C672x DSP
Example 1. Pseudo Code (continued)

```c
// trigger FIFO read to prepare processing buffers for next round
trigger_FIFO_read( nextWkBufs );

// call equalizer module for left and right channel
if ( parameter_changed( eqParamL ) )
    equalizer_design( eqParamL ); // translate the parameters for the algorithm
equalizer( inputBufL[currInBuf], eqOutL[currWkBufs] );
if ( parameter_changed( eqParamR ) )
    equalizer_design( eqParamR ); // translate the parameters for the algorithm
equalizer( inputBufR[currInBuf], eqOutR[currWkBufs] );

// call chorus for left and right channel
if ( parameter_changed( choParamL ) )
    chorus_design( choParamL ); // translate the parameters for the algorithm
chorus( eqOutL[currWkBufs], choDlyL[currWkBufs], choOutL[currWkBufs] );
if ( parameter_changed( choParamR ) )
    chorus_design( choParamR ); // translate the parameters for the algorithm
chorus( eqOutR[currWkBufs], choDlyR[currWkBufs], choOutR[currWkBufs] );

// call delay for left and right channel
if ( parameter_changed( dlyParamL ) )
    delay_design( dlyParamL ); // translate the parameters for the algorithm
delay( choOutL[currWkBufs], dlyWL[currWkBufs], dlyOutL[currWkBufs] );
if ( parameter_changed( dlyParamR ) )
    delay_design( dlyParamR ); // translate the parameters for the algorithm
delay( choOutR[currWkBufs], dlyWR[currWkBufs], dlyOutR[currWkBufs] );

// call reverb for left and right channel
if ( parameter_changed( revParamL ) )
    reverb_design( revParamL ); // translate the parameters for the algorithm
reverb( dlyOutL[currWkBufs], echoDlyL[currWkBufs][6], apfDlyL[currWkBufs][4], outputBufL[currOutBuf] );
if ( parameter_changed( revParamR ) )
    reverb_design( revParamR ); // translate the parameters for the algorithm
reverb( dlyOutR[currWkBufs], echoDlyR[currProcSet][6], apfDlyR[currWkBufs][4], outputBufR[currOutBuf] );

// trigger FIFO write to update the circular buffer
trigger_FIFO_write( currWkBufs );

goto app_start; // go back to start next round
```
Example 2. Equalizer Implementation

Variables:
float a1, a2, b0, b1, b2; // filter coefficients
float w[2]; // "w" variables

Function:
void equalizer( Int *in, Int *out ) {
float w, w1, w2; // temporary variables

w1 = w[0]; w2 = w[1]; // get previously saved "w"
for( i = 0; i < Ns; i++ ) {
    w = in[i] - a1*w1 - a2*w2;
    out[i] = b0*w + b1*w1 + b2*w2;
    w2 = w1;
    w1 = w;
}
w[0] = w1; w[1] = w2; // save updated "w"
}

Example 3. Chorus Implementation

Variables:
float fb, gd, gw; // coefficients for chorus (feedback, dry gain and wet gain)
float frac; // variable for sample interpolation; updated in cho_mod_delay()

Function:
void chorus( Int *in, Int *buffer, Int *out ) {

// "buffer" contains the delay samples obtained by FIFO read
// the delay for FIFO read is modulated in cho_mod_delay() function.
// After computation, the updated "buffer" will be transferred to circular buffer
// by FIFO write.

float delSample; // temporary variables

// compute for sample 0
buffer[0] = in[0] + fb * buffer[0];
out[0] = gd*in[0] + gw*buffer[0];

// compute for sample 1 ... Ns-1
for( i = Ns-1; i >= 0; i-- ) {
    // sample interpolation
    delSample = buffer[i] + frac*( buffer[i-1]-buffer[i] );

    buffer[i] = in[i] + fb * delSample;
    out[i] = gd*in[i] + gw*delSample;
}

// modulate the FIFO read delay value for the next round
cho_mod_delay( handle );
}

Variables:
float pd; // periodic delay for chorus
Int *FIFOR_DelayTableEntry; // entry for chorus in the FIFO read delay table
Int32 FIFOR_ChorusDelayStartOffset; // offset which points to the beginning of
// the circular buffer section used by this
// chorus module
Example 3. Chorus Implementation (continued)

```plaintext
Function:
void cho_mod_delay() {
    float mod; // temporary variable
    Int32 d1;
    mod = lfo_get_Sample(); // get the delay value from the LFO
    d1 = (int)floorf(mod); // get the integer part of mod
    frac = mod - d1; // get the fraction part of mod which will
    // be used for sample interpolation in chorus()
    d1 = pd - d1; // d1 is the new delay value
    // write the new delay value to the delay table entry
    *FIFOR_DlyTabEntry = d1 + FIFOR_DelayStartOffset;
}
```

Example 4. Delay Implementation

```
Variables:
float g, fb; // coefficients for gain and feedback

Function:
void delay (Int *in, Int *w, Int *out){
    // "w" contains the delay samples obtained by FIFO read
    // After computation, the updated "w" will be transferred to circular buffer
    // by FIFO write.
    for( i = 0; i < Ns; i++) {
        out[i] = in[i] + g * w[i];
        w[i] = in[i] + fb * w[i];
    }
}
```

Example 5. Reverb Implementation

```
Variables:
float gainE[6]; // ge[0..5] in figure xxx
float lp[4]; //
float fbA[4]; // feedback coefficients for APF
float acof; // for APF
float gain; // APF

Function:
void reverb( Int *in, Int *echoBuf[6], Int *apfBuf[4], Int *out ) {
    float tempin, tempout; // temporary variable
    float b = 1-a;
    // for echo effects: echoBuf[] are filled by dMAX using FIFO read
    // for all-pass filters: apfBuf[] are filled by dMAX using FIFO read
    // After computation, apfBuf[] are transferred to circular buffer using FIFO write
    for( i=0; i<Ns; i++) {
        tempin = in[i];
        // echoe filter (6 taps)
        for( k=0; k<6; k++ ) {
            in[i] = in[i] + gainE[k] * echoBufE[k][i];
        }
        // All-pass filters
```
5 Performance Analysis

In this section, the performance of block processing vs. single-sample processing will be compared and analyzed where the benefits of block processing come.

5.1 Utilizing DSP Pipeline & Reduced Function Call Overhead

Generally speaking, the DSP instructions can be more efficiently pipelined by performing the block processing. The main benefit comes from the possibility to unroll the loop so that computation instructions can be inserted in the slots while DSP is loading/storing data.

Another benefit comes from reduced function call overhead. Many audio effect algorithms look similar to a filter and are implemented as a compact function. For block-processing, the function is called once every N samples; while for single-sample processing it is called once per sample.

5.2 Interrupt and Program Cache

For single-sample processing, one interrupt is generated for each input sample received and the sample needs to be processed before the next sample comes in. Suppose the audio sample rate is 192-KHz and DSP runs at 300-MHz, this period is about 1563 DSP cycles.

When an interrupt occurs, a few operations need to be performed, like register saving, stack saving etc. before the DSP jumps into the interrupt service routine (ISR). To make it worse, the processing task which was processing the input sample is swapped out of the program cache and will be swapped back in later after ISR completes. These operations can waste hundreds of DSP cycles. Thus, there is not much room left to implement any complicated processing algorithm for single-sample processing. For block processing, one interrupt is generated after a block of samples are received.

For a block of size N, say N=32, the interrupt handling overhead is distributed to the 32 samples which significantly increases the room for sample processing.

5.3 dMAX and SDRAM Performance

Some delay based audio algorithms such as chorus need to randomly access the delay line on SDRAM to fetching delay samples. For single-sample processing, since these accesses cannot be bursted, each single access can take almost about 100 dMAX cycles. For block processing, since a block of consecutive samples are accessed for each delay tap, the average time it takes to access each sample can be significantly reduced by such burst accesses.

dMAX also makes the performance different between single-sample processing and block processing due to its event processing overhead which mainly comes from parsing the parameters in the event entry. For single-sample processing, one parsing is needed for each sample while for block processing, one parsing is needed for the whole block.

A simple experiment on C6727 has shown that the dMAX takes about 95 dMAX cycles to move a single 32-bit sample from SDRAM to on-chip SRAM, while it only takes about 156 dMAX cycles to move a block of 16 sequential samples each of which is 32-bit. For details of dMAX performance, please refer to [2].

Example 5. Reverb Implementation (continued)

```c
tempout = tempin;

for( k=0; k<4; k++ ) {
    lp[k] = b * apfBuf[k][i] + a * lp[k];
    apfBufA[k][i] = (1-fbA[k])*tempin + fbA[k] * lp[k];
    tempin = gain * lp[k] - fbA[k] * tempin;
    tempout = tempout + tempin;
}
out[i] = tempout; // output
```
6 Code User's Guide

The provided software consists 2 parts: 1) A TI Code Composer Studio™ (CCS) project which implements all the effect modules on PADK; 2) a PC side graphic user interface (GUI) which communicates to the PADK board via USB interface and is used to dynamically control each effect module.

6.1 Hardware Requirement

The following hardware is necessary to execute the provided software project:
- A PC with Windows 2000 or XP installed
- Professional Audio Development Kit (PADK) board and power supply from LYRTECH
- XDS510USB JTAG USB emulator or XDS378 JTAG parallel port emulator
- Analog input audio source generator
- Speaker with amplifier
- An audio cable connecting the source generator with the "analog in" ports 1 and 2 on the PADK
- An audio cable connecting the speaker with the "analog out" ports 1 and 2
- A USB cable connecting between the PC USB port and the PADK USB port.

Figure 20. Hardware Connection Example

Figure 20 shows a hardware connection example. The laptop plays music and transmits the audio input signal to the PADK board via the audio input ports (analog in 1 and 2). The laptop is also connected with the PADK board via the USB port through which parameters can be sent to the board to dynamically control each effect module. The audio output ports (analog out 1 and 2) are connected with the speakers.

6.2 Software Requirement

- TI CCS 3.1 installed on PC
- TI chip support library (CSL) 3.0 for C672x (provided with the project)
- PADK.lib from PADK (provided with the project)
- C672xROMPatchV1_00_00.lib and applyPatch.obj (provided with the project)

6.3 Step to Run

The following steps show how to run the project with the hardware:

1. Hardware setup
   a. Connect the JTAG emulator with the PADK board from PC
   b. Connect the audio source generator with the PADK board (“analog in” port 1 and 2)
c. Connect the speaker with the PADK board ("analog out" port 1 and 2).
d. Power on the PADK board.

2. Turn on the audio source generator.
3. Launch CCS 3.1 on PC and open the provided CCS project.
4. Build the project and load the .out file to the board through JTAG emulator. Run the code.
5. Run the GUI program.
6. Turn on the speaker. Now you can listen to the music with the implemented effects. Each effect for each channel can be dynamically controlled through the GUI.

6.4 Description of the DSP Side Software

The provided DSP project shows how to efficiently perform delay-based audio effects on the PADK hardware.

There are two independent channels in the system each of which passes through the following 4 effect module.

Equalizer→chorus→delay→reverb

Any effect module on any channel can be individually disabled or reconfigured by modifying its parameters.

The sampling rate is set to 96 kHz and will be generated by one of the onboard oscillators. The sampling frequency source will be configured using the module CLKGEN of the PADK library.

The data are received on the ADC1 input. They are demuxed by dMAX and placed to different input buffers for further processing. The output for each channel will be muxed by dMAX and sent to DAC1.

The ADC and the DAC devices will be initialized using the functions of the PADK library. These devices are connected to the DSP through the serializers of the McASP #0 as following.

ADC #1 -> McASP0 Serializer 0 (AXR0_0)
DAC #1 -> McASP0 Serializer 4 (AXR0_4)

The samples received are 32 bits each with 24 effective bits. They are truncated and processed as 16 bits samples. The data stored in the circular buffer are 16 bits too. Each output sample is shifted 16 bits left before being transmitted out.

6.4.1 "app.h"

This file mainly defines macros related to buffer organization and dMAX transfer. All the macros are explained inside the file. The following is a brief description to some key macro definitions.

6.4.1.1 Frame and Sample Size

```c
#define SAMPLES_PER_FRAME 32
// This macro defines the number of samples per frame each of which contains samples
// for both the left and right channel. It can be modified by user to tradeoff between
// performance and latency.
// The frame size for each channel is half, i.e.
// SAMPLES_PER_CHANFRM = (SAMPLES_PER_FRAME/2)
```

```c
#define BYTES_PER_SAMPLE 4
// Each sample received from and transmitted to McASP is 4 bytes.
```

```c
#define BYTES_PER_SAMPLE_STORED 2
// The size of each sample stored in the processing buffers are circular buffer is
// 2 bytes.
```
### 6.4.1.2 dMAX Events

```c
#define INPUT_RCV_BIT 0
#define OUTPUT_XMT_BIT 1
#define UPDATE_CIR_BUF_BIT 2
#define UPDATE_WK_BUF_BIT 3
// These 4 macros define the TCC bit to be set when a dMAX transfer is finished.
// They are also used to indicating the various buffer status by setting the variable
// "bufRdyFlag".
// When a frame of input samples are received from McASP, bit INPUT_RCV_BIT is set.
// When a frame of output samples are transmitted to McASP, bit OUTPUT_XMT_BIT is set.
// When a FIFO Write Transfer is completed, bit UPDATE_CIR_BUF_BIT is set.
// When a FIFO Read Transfer is completed, bit UPDATE_WK_BUF_BIT is set.
```

### 6.4.1.3 appBuf Organization

The *appBuf* contains data which are accessed frequently and resides in the DSP internal memory. It is organized as shown below.

<table>
<thead>
<tr>
<th>appBuf base</th>
<th>FIFO descriptor</th>
<th>32 bytes</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>FIFO write</td>
<td></td>
</tr>
<tr>
<td></td>
<td>delay table</td>
<td></td>
</tr>
<tr>
<td></td>
<td>14 entries</td>
<td></td>
</tr>
<tr>
<td></td>
<td>14x4=56 bytes</td>
<td></td>
</tr>
<tr>
<td></td>
<td>FIFO read</td>
<td></td>
</tr>
<tr>
<td></td>
<td>delay table</td>
<td></td>
</tr>
<tr>
<td></td>
<td>26 entries</td>
<td></td>
</tr>
<tr>
<td></td>
<td>26x4=104 bytes</td>
<td></td>
</tr>
<tr>
<td></td>
<td>Input &amp; output</td>
<td></td>
</tr>
<tr>
<td></td>
<td>PING/PONG</td>
<td></td>
</tr>
<tr>
<td></td>
<td>buffers</td>
<td></td>
</tr>
<tr>
<td></td>
<td>8 buffers, each is</td>
<td>SAMPLES_PER_CHANFRM x 4 bytes</td>
</tr>
<tr>
<td></td>
<td>Processing buffers</td>
<td>not related to FIFO</td>
</tr>
<tr>
<td></td>
<td>8 buffers, each is</td>
<td>SAMPLES_PER_CHANFRM x 4 bytes</td>
</tr>
<tr>
<td></td>
<td>Processing buffers</td>
<td>related to FIFO</td>
</tr>
<tr>
<td></td>
<td>26 for PING and 26 for PONG, 52 buffers in total, each is</td>
<td>SAMPLES_PER_CHANFRM x 4 bytes</td>
</tr>
</tbody>
</table>

**Figure 21. appBuf Organization**

Refer to **Figure 14** to see how the input/output buffers and processing buffers are organized.
6.4.1.4 cirBuf Organization

cirBuf contains the stored delay samples which consumes a fair mount of memory. It resides in the external memory and organized as shown below.

There are 14 sections in total and each section size is defined as 48000 elements. User is allowed to modify the sizes appropriately based on the delay line length required.

```c
#define FIFO_SECT_NUM 14
#define FIFO_SIZE_SECT0 48000
#define FIFO_SIZE_SECT13 48000
```

6.4.2 "AEL.h"

This file defines various structs for the effect algorithms. For each effect module, there is a parameter struct which is configured by the user and a handle struct which contains all the information needed by the algorithm for processing. The following is the example of the delay module.

```c
// parameter for the delay module; configured by the user
typedef struct AEL_TIF_DelParams {
    Int16 enable; // is the module enable? If not, the module simply does loopback.
    Int16 changed; // Has any parameter been changed?
    float gain, feedback, delay; // actual parameters for the delay module.
} AEL_TIF_DelParams;

// handle for the delay module algorithm
typedef struct AEL_TIF_DelHandle {
    Int16 chan; // is this handle for the left or right channel?
    Int16 enable; // is the module enabled?
    float gain, feedback; // algorithm parameters?
    Int16 *delBuf; // buffer pointers to the delay samples
    Int32 sampDelay; // delay length
    AEL_TIF_DelDlyTbAcc dlyTbAcc; // struct for accessing the FIFO delay tables
} AEL_TIF_DelHandle;
```
6.4.3 "presets.h"

This file defines all the parameter macros to configure each effect module. User is allowed to modify those parameters following the corresponding struct format defined in the "AEL.h".

6.4.4 "main.c"

This file contains three functions: main( ), nmi_isr( ) and setup_interrupts( ).

6.4.4.1 main( )

This is the entry function of the whole application. It does the following:

- Initialize and configure the McASP device using CSL.
- Initialize the USB module on PADK.
- Initialize and configure the dMAX using CSL.
  - The two general transfers are configured to use HiMAX (high priority) to receive transmit input/output samples from/to McASP. dMAX synchronizes with McASP for every sample transfer. After one frame of samples are transferred, an interrupt is generated to notify the DSP.
  - The FIFO read and write transfers are configured to use LoMAX (low priority). After the whole transferred is finished, dMAX synchronizes with McASP and an interrupt is generated to notify the DSP.
  - At the beginning, PING input buffers are used for receiving samples; PING output buffers are used to transmit samples; PING processing buffers are used by DSP for computation and PONG processing buffers are filled by samples in the circular buffer using FIFO read for the next round.
- Initialize the A/D and D/A device on PADK using PADK.lib.
- Hook the ISR routines to NMI and dMAX interrupt by calling setup_interrupts( ).
- Initialize the application by calling app_init(). This function mainly does the following.
  - Configure each effect module. All the parameters configurable by user are translated to the handle structs by the effect algorithms.
  - Clear the circular buffer and processing buffers.
- Start the application by calling app( ).

6.4.5 "app.c"

There are two key functions in this file: app( ) and DMAX_isr( ). Their behaviors are described in section 4.

6.4.6 Miscellaneous

- "eq.c": this file implements the equalizer effect algorithm.
- "chorus.c": this file implements the chorus effect algorithm.
- "LFO.c": this file implements the LFO module for the chorus effect. The LFO can be realized by one of the following four waveforms: sine, triangle, square or sawtooth. User can select any of them by configuring the chorus parameter.
- "delay.c": this file implements the delay effect module.
- "rev.c": this file implements the reverb effect module.
6.5 Description of GUI

6.5.1 Main Window

Figure 23 shows the main control interface. The functionality of each button is explained as following.

- “EQUALIZER config”: clicking it will pop out a dialog to control the equalizer module for the left or right channel.
- “CHORUS config”: clicking it will pop out a dialog to control the chorus module for the left or right channel.
- “DELAY config”: clicking it will pop out a dialog to control the chorus module for the left or right channel.
- “REVERB config”: clicking it will pop out a dialog to control the reverb module for the left or right channel.
- “Bypass Left” / “Bypass Right”: clicking it will disable all the effect modules for the left / right channel so that the audio signal simply loops back on the channel.
- “Unbypass Left” / “Unbypass Right”: clicking it will enable all the effect modules for the left / right channel.
- “Reset Left” / “Reset Right”: clicking it will reset all the modules to the start state for the left / right channel. In the start state, each module is enabled and all the parameters are set to the pre-configured values.
- “Quit”: clicking it will quit the GUI.

![Figure 23. Main GUI](image)

6.5.2 Equalizer Window

Figure 24 shows the configuration window for the equalizer module. The “LEFT” and “RIGHT” radio button on the top allows select the channel to be configured. Selecting / Deselecting the “enable” button will enable / disable the module for the channel.

The configurable parameters are: dBGain, Q, frequency and EQ type as displayed. The EQ type can be “LO_SH”, “HI_SH” or “PEAK”. By changing any of these parameters, the bi-quad filter coefficients (b1, b2, a0, a1, a2) will change appropriately.

By clicking the “Submit” button, all the parameters for the selected channel will be transmitted to the board and the effect will take place.

By clicking the “Reset” button, all the parameters for the selected channel will be set to pre-configured values and transmitted to the board.

Clicking the “Quit” button will kill the equalizer window.
6.5.3 Chorus Window

Figure 25 shows the configuration window for the chorus module. The functionalities of “LEFT”, “RIGHT” and “enable” buttons are the similar as the ones in the equalizer window.
The configurable parameters are: gd, gw, fb, predelay, depth, rate, and wave as displayed. The wave parameter allows select the wave table for LFO modulation and can be “SINE”, “SQUARE”, “TRIANGLE” or “SAWTOOTH”.

The functionalities of “Submit”, “Reset” and “Quit” buttons are similar as the ones in the equalizer window.

6.5.4 Delay Window

Figure 26 shows the configuration window for the delay module. The functionalities of “LEFT”, “RIGHT” and “enable” buttons are the similar as the ones in the equalizer window.

The configurable parameters are: fb, g, and D as displayed.

The functionalities of “Submit”, “Reset” and “Quit” buttons are similar as the ones in the equalizer window.

6.5.5 Reverb Window

Figure 27 shows the configuration window for the reverb module. The functionalities of “LEFT”, “RIGHT” and “enable” buttons are the similar as the ones in the equalizer window.

The configurable parameters are: g, ge[0] … ge[5], D0 … D5, DA[0] … DA[3], delay and cut freq as displayed. By changing g, delay or cut freq, the coefficients a, b and lp[k] (k=0…3) for the all pass filter (APF) k will change appropriately.

The functionalities of “Submit”, “Reset”, and “Quit” buttons are similar as the ones in the equalizer window.
7 Reference

1. TMS320C6727, TMS320C6726, TMS320C6722 Floating-Point Digital Signal Processors, (SPRS268).
2. TMS320C672x DSP Dual Data Movement Accelerator (dMAX) Reference Guide (SPRU795).
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